



ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
PARAMETER	CONDITION	SYMBOL	VALUE	UNIT
INPUT				
IRED continuous forward current		I_F	50	mA
IRED reverse voltage		V_R	5	V
Input power dissipation		P_{diss}	80	mW
OUTPUT				
DC or peak AC load voltage		V_L	250	V
Continuous DC load current at 25 °C, one channel		I_L	200	mA
Continuous DC load current at 25 °C, two channels		I_L	140	mA
SSR output power dissipation		P_{diss}	550	mW
SSR				
Ambient temperature range		T_{amb}	-40 to +100	°C
Storage temperature range		T_{stg}	-40 to +150	°C
Soldering temperature	$t = 10\text{ s max.}$	T_{sld}	260	°C

Note

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
IRED forward current, switch turn-on	$I_L = 100\text{ mA}$, $t = 10\text{ ms}$	I_{Fon}	-	0.4	2	mA
IRED forward current, switch turn-off	$V_L = \pm 200\text{ V}$	I_{Foff}	0.05	0.35	-	mA
IRED forward voltage	$I_F = 10\text{ mA}$	V_F	-	1.36	1.5	V
IRED reverse current	$V_R = 5\text{ V}$	I_R	-	-	10	μA
OUTPUT						
On-resistance	$I_F = 5\text{ mA}$, $I_L = 50\text{ mA}$	R_{ON}	-	12	15	Ω
Off-resistance	$I_F = 0\text{ mA}$, $V_L = \pm 100\text{ V}$	R_{OFF}	1.0	5000	-	$\text{G}\Omega$
Off-state leakage current	$I_F = 0\text{ mA}$, $V_L = \pm 100\text{ V}$	I_O	-	< 1	100	nA
	$I_F = 0\text{ mA}$, $V_L = \pm 200\text{ V}$	I_O	-	< 1	500	nA
Output capacitance pin 3 to 4	$I_F = 0\text{ mA}$, $V_L = 1\text{ V}$, 1 MHz	C_O	-	39	-	pF
	$I_F = 0\text{ mA}$, $V_L = 50\text{ V}$, 1 MHz	C_O	-	6	-	pF
Current limit AC/DC	$I_F = 5\text{ mA}$, $t = 5\text{ ms}$, $V_L = \pm 6\text{ V}$	I_{limit}	300	440	550	mA
TRANSFER						
Capacitance (input to output)	$V_{IO} = 1\text{ V}$	C_{IO}	-	0.4	-	pF

Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.

SWITCHING CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Turn-on time	$I_F = 5\text{ mA}$, $I_L = 50\text{ mA}$	t_{on}	-	0.20	0.5	ms
Turn-off time	$I_F = 5\text{ mA}$, $I_L = 50\text{ mA}$	t_{off}	-	0.03	0.2	ms

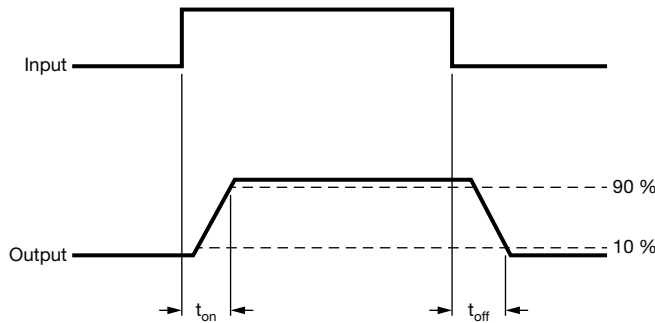
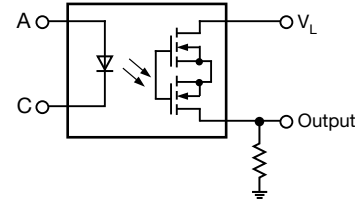


Fig. 1 - Timing Schematic



SAFETY AND INSULATION RATINGS				
PARAMETER	CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		40 / 100 / 21	
Pollution degree	According to DIN VDE 0109		2	
Comparative tracking index	Insulation group IIIa	CTI	175	
Maximum rated withstanding isolation voltage	According to UL1577, t = 1 min	V _{ISO}	5300	V _{RMS}
Maximum transient isolation voltage	According to DIN EN 60747-5-5	V _{IOTM}	8000	V _{peak}
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5	V _{IORM}	890	V _{peak}
Insulation resistance	V _{IO} = 500 V, T _{amb} = 25 °C	R _{IO}	≥ 10 ¹²	Ω
	V _{IO} = 500 V, T _{amb} = 100 °C	R _{IO}	≥ 10 ¹¹	Ω
Output safety power	One channel	P _{SO}	640	mW
	Two channels		480	
Input safety current	One channel	I _{SI}	240	mA
	Two channels		200	
Safety temperature		T _S	175	°C
Creepage distance	DIP-8		≥ 7	mm
Clearance distance			≥ 7	mm
Creepage distance	SMD-8		≥ 8	mm
Clearance distance			≥ 8	mm
Insulation thickness		DTI	≥ 0.4	mm
Input to output test voltage, method B	V _{IORM} × 1.875 = V _{PR} , 100 % production test with t _M = 1 s, partial discharge < 5 pC	V _{PR}	1669	V _{peak}
Input to output test voltage, method A	V _{IORM} × 1.6 = V _{PR} , 100 % sample test with t _M = 10 s, partial discharge < 5 pC	V _{PR}	1424	V _{peak}

Note

- As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for “safe electrical insulation” only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.

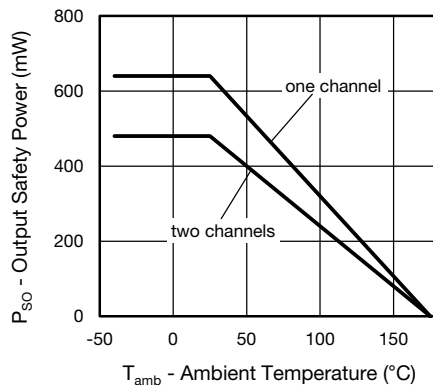


Fig. 2 - Output Safety Power vs. Ambient Temperature

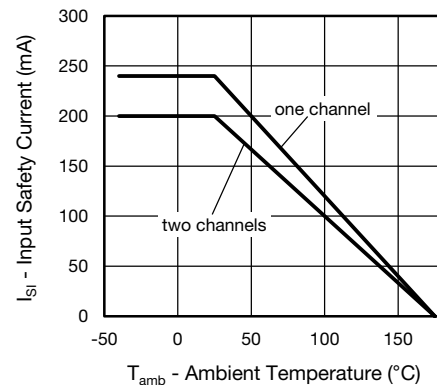


Fig. 3 - Input Safety Current vs. Ambient Temperature

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

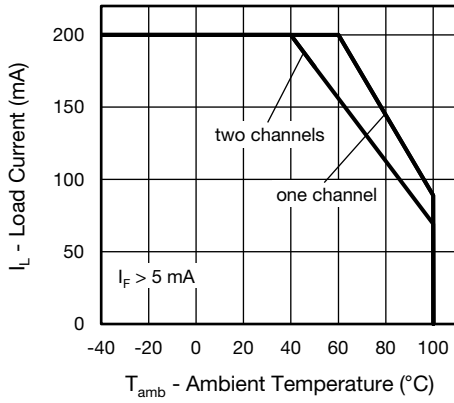


Fig. 4 - Load Current vs. Ambient Temperature

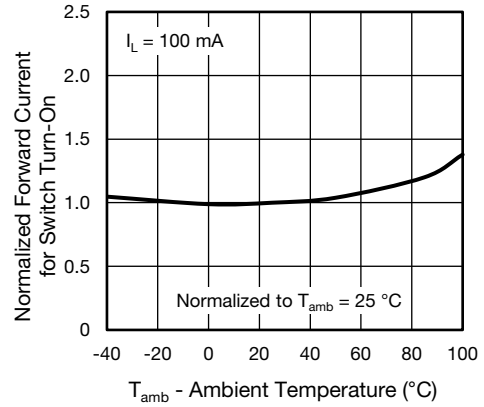


Fig. 7 - Normalized Forward Current vs. Ambient Temperature

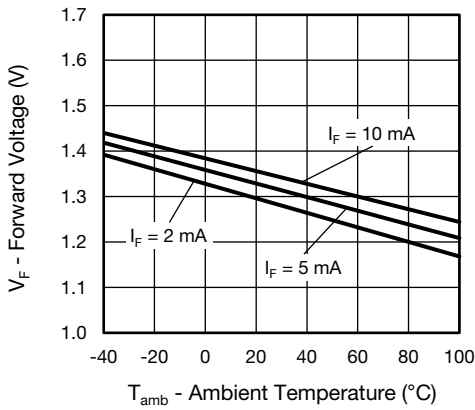


Fig. 5 - Forward Voltage vs. Ambient Temperature

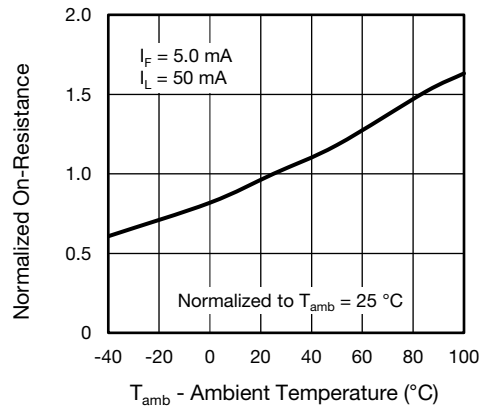


Fig. 8 - Normalized On-Resistance vs. Ambient Temperature

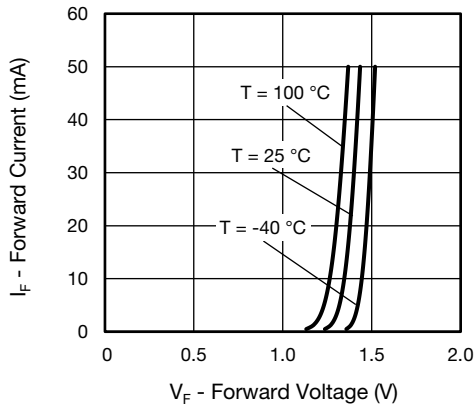


Fig. 6 - Forward Current vs. Forward Voltage

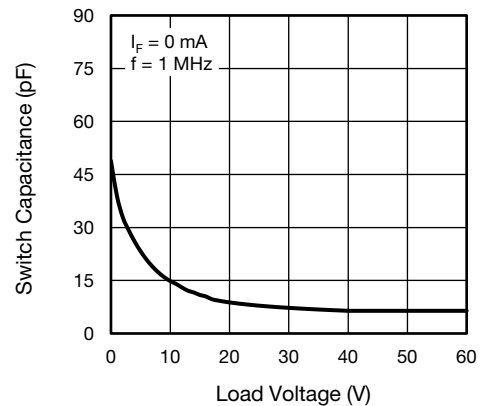


Fig. 9 - Switch Capacitance vs. Load Voltage

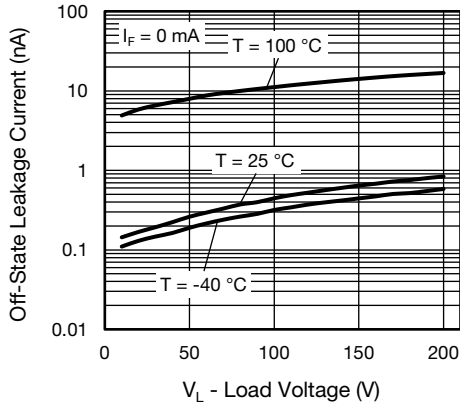


Fig. 10 - Leakage Current vs. Load Voltage

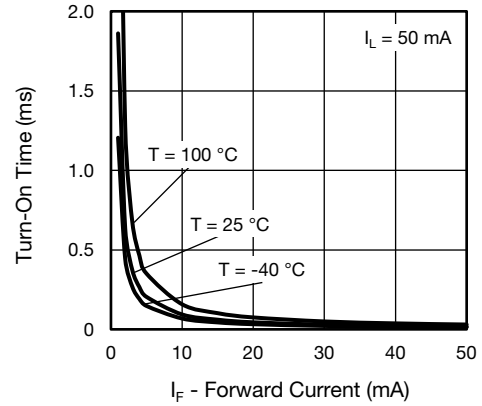


Fig. 13 - Turn-On Time vs. Forward Current

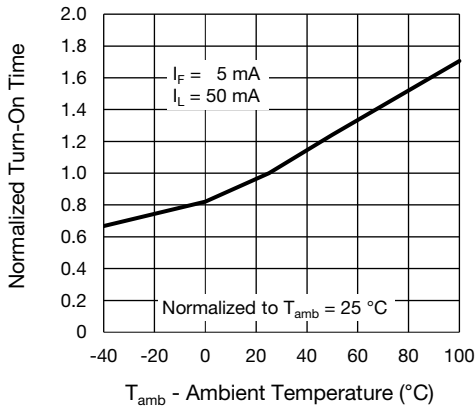


Fig. 11 - Normalized Turn-On Time vs. Ambient Temperature

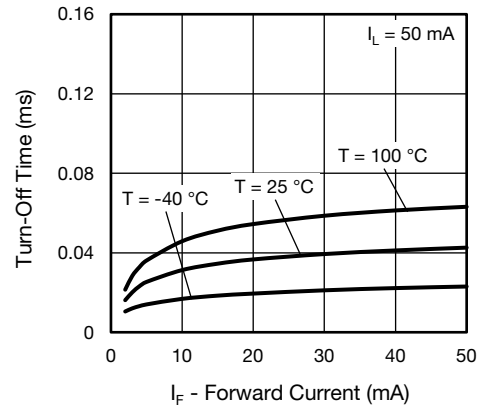


Fig. 14 - Turn-Off Time vs. Forward Current

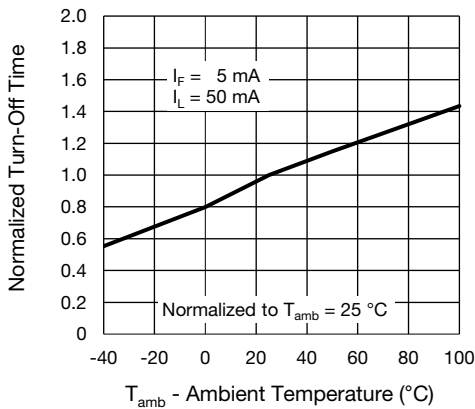
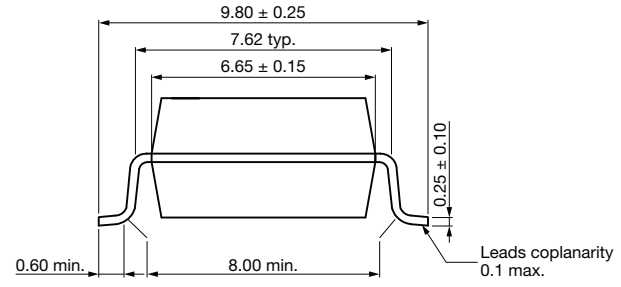
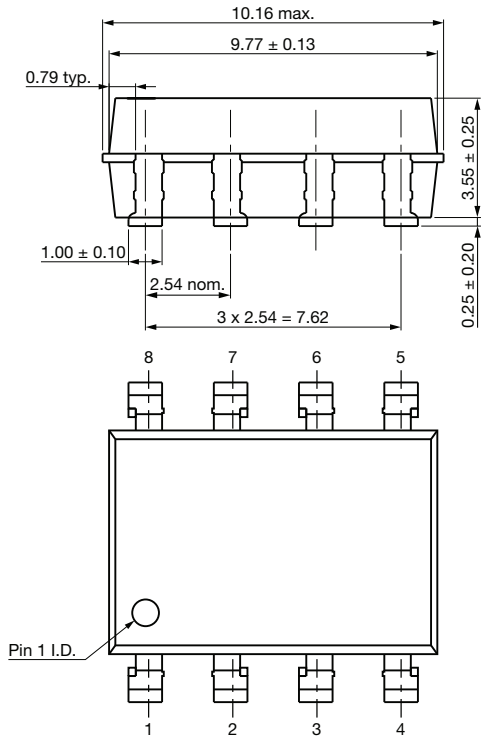


Fig. 12 - Normalized Turn-Off Time vs. Ambient Temperature

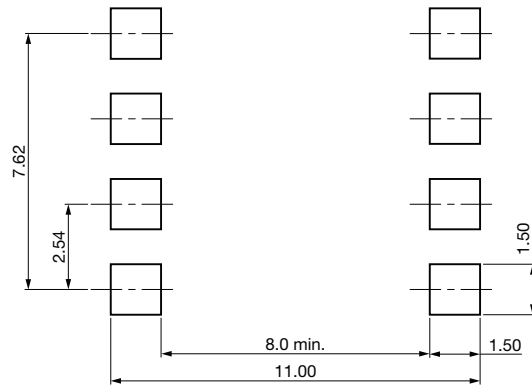


PACKAGE DIMENSIONS in millimeters

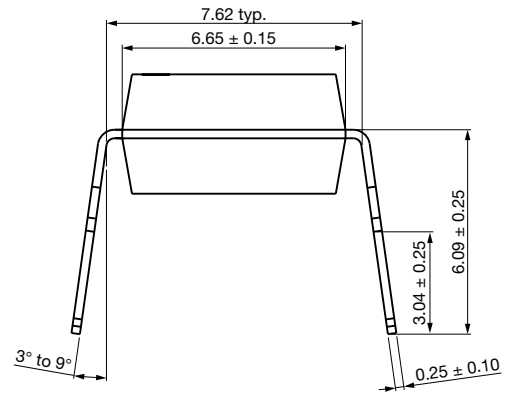
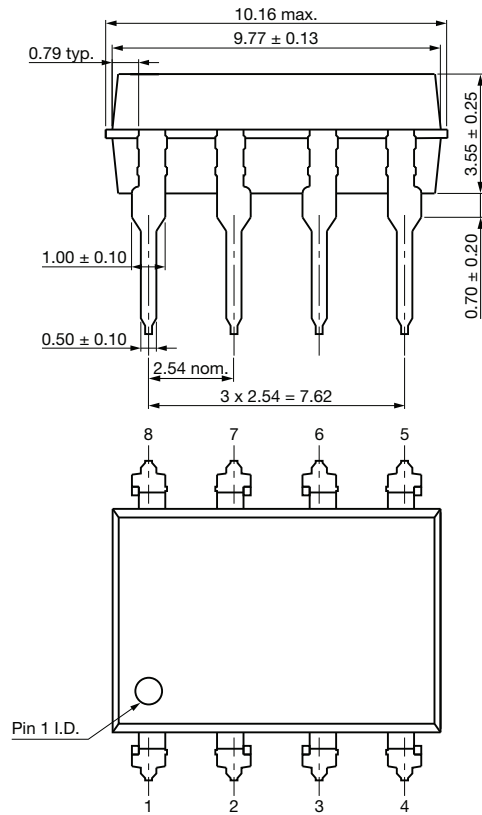
SMD-8



Recommended footprint



DIP-8





PACKAGE MARKING (example)

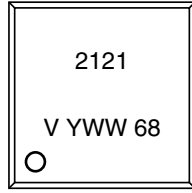


Fig. 15 - VOR2121

Note

- Package configurations (T, A, B) are not part of the package marking.

PACKING INFORMATION (in millimeters)

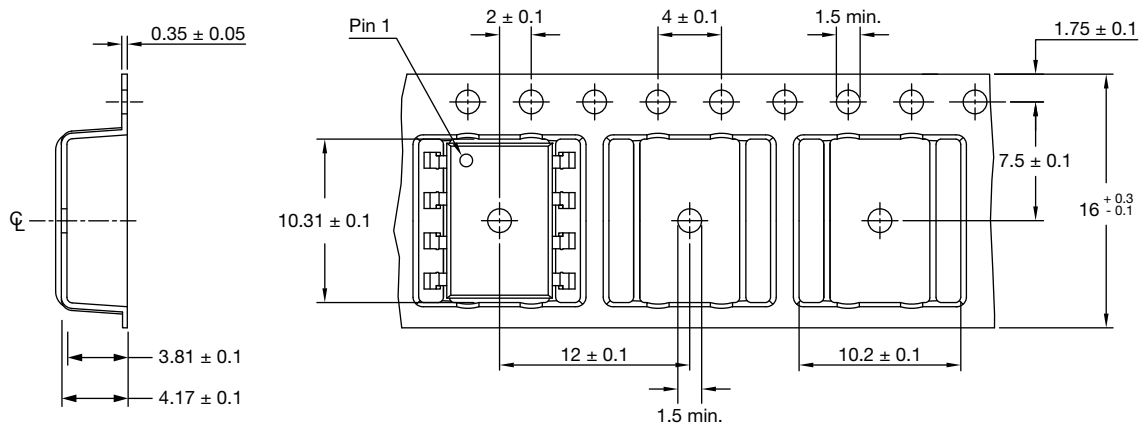
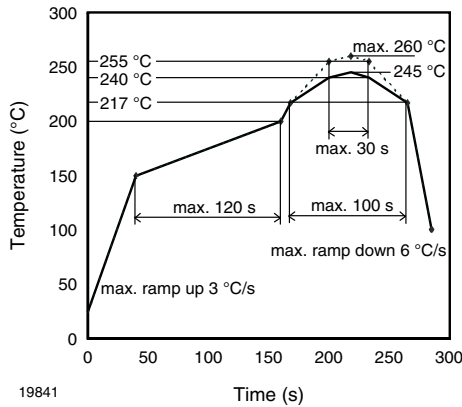


Fig. 16 - Tape and Reel Packing

TAPE AND REEL PACKING	
TYPE	UNITS/REEL
SMD-8	1000

TUBE PACKING			
TYPE	UNITS/TUBE	TUBES/BOX	UNITS/BOX
SMD-8	50	40	2000
DIP-8	50	40	2000

SOLDER PROFILES



19841

Fig. 17 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020 for SMD Devices

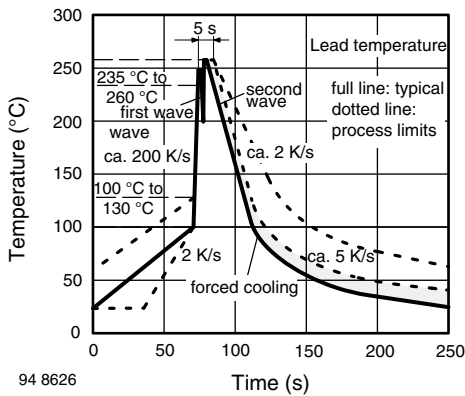
HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2

Floor life: unlimited

Conditions: $T_{amb} < 30\text{ °C}$, RH < 85 %

Moisture sensitivity level 1, according to J-STD-020



94 8626

Fig. 18 - Wave Soldering Double Wave Profile According to J-STD-020 for DIP Devices



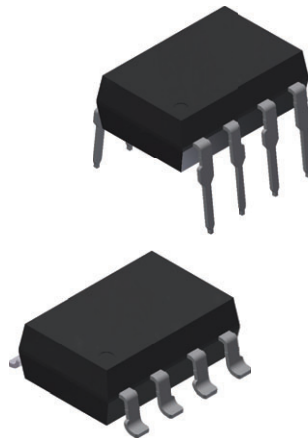
Footprint and Schematic Information for VOR2121

The footprint and schematic symbols for the following parts can be accessed using the associated links. They are available in Eagle, Altium, KiCad, OrCAD / Allegro, Pulsonix, and PADS.

Note that the 3D models for these parts can be found on the Vishay product page.

PART NUMBER	FOOTPRINT / SCHEMATIC
VOR2121A8	www.snapeda.com/parts/VOR2121A8/Vishay/view-part
VOR2121B8	www.snapeda.com/parts/VOR2121B8/Vishay/view-part
VOR2121B8T	www.snapeda.com/parts/VOR2121B8T/Vishay/view-part

For technical issues and product support, please contact optocoupleranswers@vishay.com.





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